

ADS42LBx9EVM

The ADS42LB49 and ADS42LB69 are dual-channel, 250-MSPS, analog-to-digital converters that are 14bit and 16-bit resolutions, respectively. The ADS42LB49EVM and ADS42LB69EVM (ADS42LBx9EVM) are specifically suited for interfacing with TI's TSW1400EVM to capture and display waveforms from the ADC. The EVM schematic, BOM, and layout files are found in the design package in the <u>ADS42LB69EVM</u> product folder on <u>www.ti.com</u>.

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1 Introduction

1.1 Overview

The ADS42LB49EVM and ADS42LB69EVM (ADS42LBx9EVM) are evaluation modules (EVMs) that allow for the evaluation of TI's ADS42LB69 and ADS42LB69. The ADS42LB49 and ADS42LB69 (ADS42LBx9) are dual-channel, low-power, 250-MSPS analog-to-digital converters (ADC) with 14-bit and 16-bit resolutions, respectively and buffered analog inputs and LVDS outputs. The EVM has transformer coupled analog and clock inputs to accommodate a wide range of signal sources and frequencies. The ADS42LBx9 is programmable through an easy-to-use software GUI enabling quick configuration for a variety of uses.

The ADS42LBx9EVM is designed to mate with the TSW1400EVM which is a full-function data-capture card. The High Speed Data Converter Pro (HSDCPro) software GUI can then process the data from the TSW1400EVM to quickly assess the performance of the ADS42LBx9. It is also compatible with Altera and Xilinx FPGA development platforms which have FMC or HSMC connectors, via the appropriate interposer card.

1.2 Block Diagram

The block diagram for the ADS42LBx9EVM is shown in Figure 1. The various inputs, outputs, and jumpers of the ADS42LBx9EVM are described in Table 1.

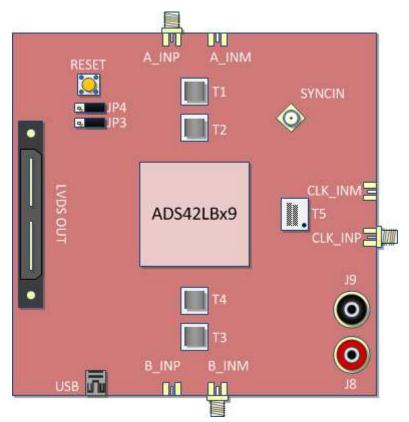


Figure 1. Block Diagram of the ADS42LBx9EVM

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Table 1. Input and Output Connectors and Jumper Descriptions of the ADS42LBx9EVM

Component	Description					
A_INP	Single-ended analog input for channel A					
B_INM Single-ended analog input for channel B						
CLK_INM	Single-ended ADC clock input					
J8	Positive power connection (3.3 V)					
J9	Negative power connection (GND)					
USB	USB connection					
LVDS OUT	LVDS connector to connect to the TSW1400					
SYNCIN	ADC sync input					
RESET	Switch to reset the ADC using the RESET pin					
JP4	ADC CNTRL1 pin, controls power down modes (default: short 2-3)					
JP3	ADC CNTRL2 pin, controls power down modes (default: short 2-3)					

2 Software Control

This section provides installation instructions for the ADS42LBx9 GUI and descriptions of the various controls.

2.1 Installation Instructions

- 1. The software can be downloaded from the <u>ADS42LB69EVM</u> product page on <u>www.ti.com</u>. Find the page by searching for *ADS42LB69EVM*.
- 2. Extract the files from the zip file named *ADS42LBx9 GUI vXpY installer.zip* where XpY represents the version number.
- 3. Run *setup.exe* and follow the installation prompts.
- 4. Start the GUI by going to Start Menu \rightarrow All Programs \rightarrow Texas Instruments ADCs \rightarrow ADS42LBx9 GUI.
- 5. When plugging the board into the computer for the first time through the USB cable, you are prompted to install the USB drivers:
 - Microsoft[®] Windows[®] XP: If Windows XP does not automatically install the drivers, follow the prompts on the screen to do so. Do not let Windows XP search Microsoft Update for the drivers, but do let Windows XP install the drivers automatically.
 - Windows 7: After installing the GUI, Windows 7 should automatically be able to install the drivers for the ADS42LBx9EVM with no user input.



2.2 Software Operation

The software GUI allows full programming control of the ADS42LBx9 device. Figure 2 shows the GUI front panel which contains a block diagram of the ADS42LBx9. Detailed descriptions for each screen of the GUI are given in this section. Please refer to the ADS42LBx9 datasheet (<u>SLAS904</u>) for more detailed explanations of the register fields.

2.2.1 Block Diagram Tab

Figure 2 shows the top-level view of the GUI which contains the block diagram of the ADS42LBx9. Along the top of the GUI is an indicator which informs of the USB connection status and a button to re-establish the connection with the ADS42LBx9 EVM. Having the USB link disconnected or having the drivers of the EVM not installed will turn this indicator off.

On the bottom side of the GUI a status bar reports the current application state. Double clicking on the left field of the status bar displays the complete status log of the application in a separated window.

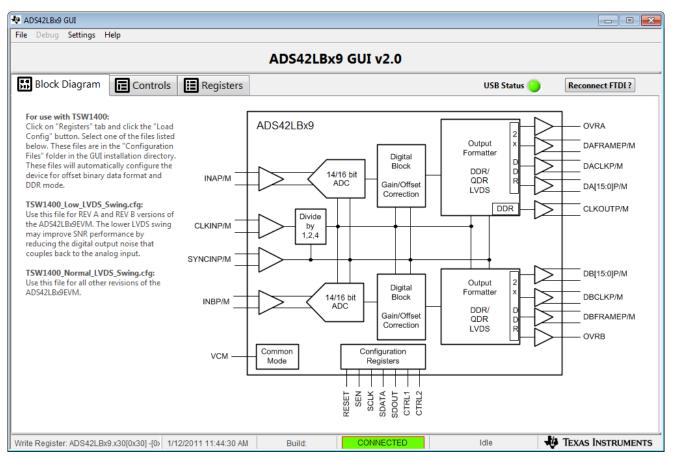


Figure 2. Block Diagram Windows of the ADS42LBx9 GUI v2.0



2.2.2 Controls Tab

The *Controls* tab of the ADS42LBx9 GUI enables quick configuration of key parameters of the data converter. For more configuration options, refer to Section 2.2.3.

ADS42LBx9 GUI												
File Debug Settings Help												
ADS42LBx9 GUI v2.0												
Block Diagram Controls	egisters	USB Status 🧿 Reconnect FTDI ?										
Reset and Power Down Input Clock	LVDS Data Output Timing	Data Output Format										
Device Reset Input Clock Divider:	Enable CLKOUT Delay 🔲 Sample Rate (Hz) 0.0000	Data Format QDR or DDR Mode?										
Stand By Ch A Power Down Ch B Power Down SYNC Enable	DDR Output Timing: The relative output delay can be calculated based on P[ns] = T/R - 1, where T is the sample clock period (ns) and R is the programmed value below.	Offset Binary DDR Mode 💌										
Digital Gain Controls	Divider (R) Output Delay Enter "Sample Rate" above for calculation of the output delay.	LVDS Buffer Controls										
Enable Gain A Ch A Gain Ch A FS Voltage	QDR Output Timing: The relative output delay can be calculated based on P[ns] = 0.5 * (T/R - 1), where T is the sample clock period (ns) and R is the programmed value	LVDS Low Level Enable										
Enable Gain B Ch B Gain Ch B FS Voltage	Ch A Divider (R) Ch A Delay Invert Ch A CLKOUT 4 0.000 ns Normal	LVDS Low Level LVDS High Level										
Digital Test Patterns	Ch B Divider (R) Ch B Delay Invert Ch B CLKOUT	LVDS Data Strength LVDS CLKOUT Strength										
Ch A Test Pattern:												
Normal Operation	Low Frequency Mode Over Range Detection Control	ls										
Ch B Test Pattern:	Set these bits to improve data output timing when using sample rates below	VR Fast OVR Threshold:										
Normal Operation	140 MSPS.	0 255										
Custom Pattern 1 Custom Pattern 2	LOW FREQ DDR Which OVR on OVR Pin?	Ch A Fast OVR Voltage Ch B Fast OVR Voltage										
× 0000 x 0000	LOW FREQ QDR Normal OVR	0.000 V 0.000 V										
Nrite Register: ADS42LBx9.x30[0x30] -[0> 1/12/2011 1	1:44:30 AM Build: CONNECTED	Idle TEXAS INSTRUMENTS										

Figure 3. Controls Tab of the ADS42LBx9 GUI v2.0

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Software Control



2.2.3 Registers Tab

The *Registers* tab is used to access the ADC registers as well as loading or saving a configuration. Figure 4 shows a screenshot of the *Registers* tab.

				A	DS42	2LBx9	GU	l v2.0							
Block Diagram	Controls	Regist	ers								USB St	atus 🤇		Reconne	ect FTDI ?
egister Map			03				Write	e Data	Post	ster Data			1	Transfer F	Read to Write
lock / Register Name	Address	Default	Mode	Size	LW*	LR* 🔺	×	0.	Kegi	ster Data					
ADS42LBx9		Deroon	moue	Dill			12	<u>0</u> .	1	R W					
x04	0x04	0x00	R/W	8	0x00	0x6F	Wr	ite Register							
×05	0x05	0x00	R/W	8	0x00	0x80	_								
x06	0x06	0x00	R/W	8	0x00	0x80		Write All							
x07	0x07	0x00	R/W	8	0x00	0x00	Rea	d Data							
×08	0x08	0x00	R/W	8	0x18	0x18		0.000000000							
x0B	0x0B	0x00	R/W	8	0x00	0x00	d	0							
x0C	0x0C	0x00	R/W	8	0x00	0x00	De	ad Register							
x0D	0x0D	0x00	R/W	8	0x00	0x6C	.ne	au negister							
x0F	0x0F	0x00	R/W	8	0x00	0x00 ≡		Read All							
x10	0x10	0x00	R/W	8	0x00	0x00									
x11	0x11	0x00	R/W	8	0x00	0x00	Curi	rent Address							
x12	0x12	0x00	R/W	8	0x00	0x00	×	0							
x13	0x13	0x00	R/W	8	0x00	0x00	NI-4	e: Load							
x14	0x14	0x00	R/W	8	0x00	0x00		e: Load fig will							
x15	0x15	0x00	R/W	8	0x01	0x01		rwrite all							
x16	0x16	0x00	R/W	8	0x00	0x00		isters.							
x17	0x17	0x00	R/W	8	0x00	0x00	neg	Sec. St.							
x18	0x18	0x00	R/W	8	0x00	0x00		ad Config							
x1F	0x1F	0x00	R/W	8	0x00	0x00		du Conny							
x30	0x30	0x00	R/W	8	0x00	• 00x0	Sa	ave Config							
	*[.W> Li	ast Write	; *LR	-> Last	Read									
egister Description				105			Bloc	:k		Address		Write Da	ata	Read D	ata_Generic
						*	AD	S42LBx9		× 0		x	0	×	0
												Write	Register	Read	Register

Figure 4. Registers Tab of the ADS42LBx9 GUI v2.0

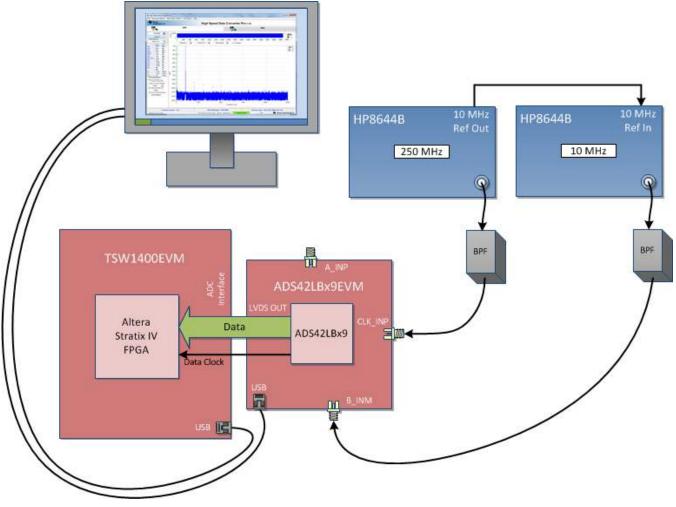


3 Basic Test Setup

This section outlines basic testing of the ADS42LBx9EVM.

3.1 Test Block Diagram

The test setup for the ADS42LBx9EVM is shown in Figure 5. The TSW1400EVM is used to capture data from the ADS42LBx9, which is then transferred to the computer for analysis in the HSDCPro software tool. The analog signal source shown is an HP8644B signal generator, however any analog signal source can be used. The clock source is also an HP8644B, but other clock sources can be used, such as a TI clock-chip EVM. Note that there are filters on both the analog and clock sources, which is necessary to achieve the best performance.





3.2 TSW1400EVM Setup

See the TSW1400EVM User's Guide (<u>SLWU079</u>) for a more detailed explanation of the TSW1400 setup and its features. This document assumes that the HSDCPro software and the TSW1400 pattern capture and generation board are both installed and functioning properly. This information can be found at http://www.ti.com/tool/tsw1400evm

http://www.ti.com/tool/tsw1400evm.



Basic Test Setup

www.ti.com

3.3 ADS42LBx9EVM Quick-Start Procedure

3.3.1 TSW1400 Data Capture Card

- 1. Connect a 5-V power supply to connector *J12* of the TSW1400EVM.
- 2. Flip switch SW7 to the ON position.
- 3. Insert a USB cable into the USB port on the TSW1400. Connect the other end to the PC.

3.3.2 ADS42LBx9EVM

- 1. Connect a 3.3-V power supply to the banana jacks, *J8* and *J9*. Connect the positive end to *J8* and the negative end to *J9*.
- 2. Connect a USB cable to the USB port on the ADS42LBx9EVM and connect the other end to the PC.
- 3. Connect a clock to the SMA connector labeled *CLK_INM*. The maximum clock frequency is 250 MHz and the clock should be around 1 Vpp. A smaller voltage may reduce the SNR performance. A bandpass filter should be placed on the clock in order to achieve the best SNR performance.
- 4. Connect a signal source to either analog input SMA connector, *A_INP* or *B_INM*. For single-tone testing, a bandpass filter should be used to achieve the best SNR and harmonic performance.
- 5. Connect the ADS42LBx9EVM to the TSW1400 by connecting *J7* on the ADS42LBx9EVM to the ADC Interface connector on the bottom of the TSW1400.
- 6. Press the *RESET* switch, *SW1* on the ADS42LBx9EVM.

3.3.3 ADS42LBx9 GUI

- 1. Start the ADS42LBx9 GUI by selecting Start Menu \rightarrow Program Files \rightarrow Texas Instruments ADCs \rightarrow ADS42LBx9 GUI.
- 2. Verify that the board is properly connected by looking at the USB Status indicator on the top right corner of the GUI. If the indicator is not green then click *Reconnect FTDI* ? until the connection with the board is established.
- 3. Follow the instructions displayed on the *Block Diagram* to program the ADC.

3.3.4 High Speed Data Converter Pro (HSDCPro)

- 1. Start the HSDCPro software tool by selecting Start Menu \rightarrow All Programs \rightarrow Texas Instruments ADCs \rightarrow High Speed Data Converter Pro.
- When prompted for the serial number of the board, select the serial number that represents the TSW1400 that has been connected to the ADS42LBx9. This number is on a sticker on the TSW1400 board.
- 3. Click the *ADC* tab to display the ADC working environment.
- 4. In the *Select ADC* drop-down box select either *ADS42LB49* or *ADS42LB69*, depending on which EVM is being used. If it asks to download the firmware, select *Yes*. Multiple LEDs light up on the TSW1400, once the firmware has finished downloading.
- 5. Select *Single Tone* from the *Test Selection* drop-down menu.
- 6. At the bottom-left corner, enter *250M* in the *ADC Output Data Rate* box, or another value if a clock other than 250 MHz is used. Enter the input frequency into the *ADC Input Target Frequency* box. Press the Enter key.
- 7. If a windowing function is desired, then *Blackman* should be selected above the plot window. If the signals are synchronized and coherent, select *Rectangular*.
- 8. All boards and software are now setup. Click the *Capture* button. A sample capture is shown in Figure 6 for the ADS42LB69 with a 250-MHz clock and 10-MHz input frequency.

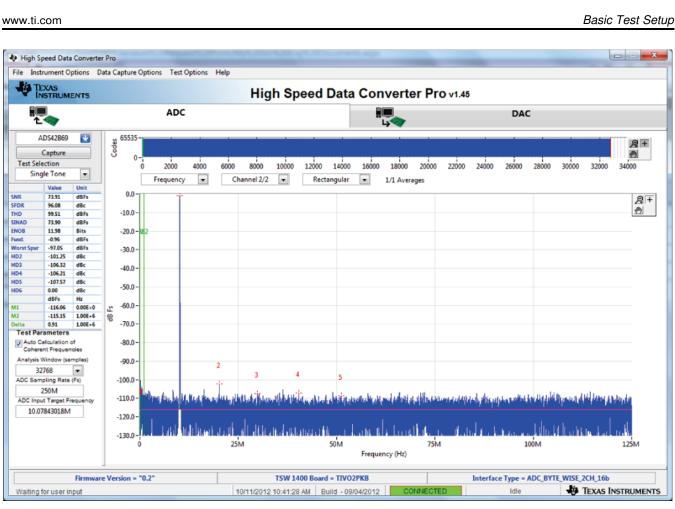


Figure 6. ADS42LB69 Sample Capture using the TSW1400

1

TEXAS

STRUMENTS

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- 3 Regulatory Notices:
 - 3.1 United States
 - 3.1.1 Notice applicable to EVMs not FCC-Approved:

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に 輸入される評価用キット、ボードについては、次のところをご覧ください。 http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 4 EVM Use Restrictions and Warnings:
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
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